

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT4606951

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
PARMESHWR PRASAD	09/19/2017
YOGESH P. KULKARNI	09/19/2017
RECEIVING PARTY DATA	
Name:	Dell Products L.P.
Street Address:	One Dell Way
City:	Round Rock
State/Country:	TEXAS
Postal Code:	78682-2244
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15712409
CORRESPONDENCE DATA	
Fax Number:	(512)391-2173
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	512.236.2023
Email:	bprewitt@docket.com
Correspondent Name:	JACKSON WALKER L.L.P.
Address Line 1:	100 CONGRESS AVENUE
Address Line 2:	SUITE 1100
Address Line 4:	AUSTIN, TEXAS 78701
ATTORNEY DOCKET NUMBER:	102450.00447
NAME OF SUBMITTER:	MINDY MAYER
SIGNATURE:	/mindy mayer/
DATE SIGNED:	09/22/2017
Total Attachments: 3	
source=109450.01 Assignment#page1.tif	
source=109450.01 Assignment#page2.tif	
source=109450.01 Assignment#page3.tif	

ASSIGNMENT

WHEREAS, **PARMESHWR PRASAD**, a citizen of the Republic of India, residing at 2-206 SLS Sunrise Bhognahalli Road, Kaverappa Layout, Kadubeesanahalli, Panathur, Bengaluru, Karnataka 560103, and **YOGESH P. KULKARNI**, a citizen of the United States of America, residing at 3600 Aquamarine Drive, Round Rock, Texas 78681, and hereinafter called the "Assignors", have made the invention described in the United States patent application entitled *Systems and Methods for Dynamically Modifying Memory Namespace Allocation Based on Memory Attributes and Application Requirements*, Attorney Docket No. 102450.00447 (109450.01), for a full description of which reference is here made to an application for Letters Patent of the United States filed on **September 22, 2017** and assigned Application Serial No. **15/712409**; and


For good and valuable consideration, the receipt of which is hereby acknowledged, we hereby also sell, assign and transfer unto DELL PRODUCTS L.P., the entire right, title and interest in and to the invention and in and to applications for Letters Patent therefor in the United States of America and all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the invention and the applications for Letters Patent in foreign countries, and we further authorize DELL PRODUCTS L.P. to apply for Letters Patent in foreign countries directly in its own name, and to claim priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

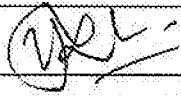
We hereby authorize and request the Commissioner of Patents of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation, continuation-in-part, or reissue, to DELL PRODUCTS L.P., for the sole use and benefit of DELL PRODUCTS L.P., its successors, assigns and legal representatives, to the full end of the term for which the Letters Patent may be granted, the same as they would have been held and enjoyed by me had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to DELL PRODUCTS L.P.

We agree that, when requested, we will, without charge to DELL PRODUCTS L.P., but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents for the inventions in any and all

countries and for vesting title thereto in DELL PRODUCTS L.P., its successors, assigns and legal representatives or nominees.

We covenant with DELL PRODUCTS L.P., its successors, assigns and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license or other encumbrance.

NAME OF FIRST INVENTOR	PARMESHWR PRASAD
SIGNATURE OF FIRST INVENTOR	
DATE	09/19/2017

NAME OF SECOND INVENTOR	YOGESH P. KULKARNI
SIGNATURE OF SECOND INVENTOR	
DATE	9/19/2017